| ABSOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES®<br>Material Composition<br>© Copyright 2005. IPC, Banı<br>international and Pan-Americ | nockburn. Illinois. A  | ll rights reserved untions. | under both | This docume<br>level parts, tl | ent is a declaration e   | on of the suncompasses | ibstances<br>s all lower | within the manufacture<br>level materials for w | urer listed which the | item. Note:<br>nanufacture | if the item is an as<br>r has engineering | ssembly with lower responsibility. |  |
|--|--|-----------------------------|------------|--------------------------------|--|------------------------|--------------------------|---|-----------------------|----------------------------|---|------------------------------------|--|
|  | IPC Web Site for Information on IPC-1752 Standard Form Typ<br>http://www.ipc.org/IPC-175x Distribute |                             |            |                                | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materi |                        |                          |   |                       | als and Mfg Information    |   |                                    |  |
| Supplier Information   |  |                             |            |                                |  |                        |                          |   |                       |                            |   |                                    |  |
| Company name* Company unique ID  |  |                             |            | Unique ID Authority            |  |                        |                          | Response Date*                                  |                       |                            |   |                                    |  |
| onsemi   | emi  |                             |            |                                |  |                        |                          |   |                       | 2023-06-08                 |   |                                    |  |
| Contact Name   | Title - Contact  |                             |            | 1                              | Phone - Contact*   |                        |                          |   | Email -               | Email - Contact*           |   |                                    |  |
| Product-Env-Stewards   | duct-Env-Stewards Product Enviro Compliance  |                             |            | NA                             |  |                        |                          | Product-Env-Stewards@onsemi.com                 |                       |                            |   |                                    |  |
| Authorized Representative* Title - Representative  |  |                             |            | Phone - Representative*        |  |                        |                          | Email - Representative*                         |                       |                            |   |                                    |  |
| Product-Env-Stewards   | riro Compliance  |                             | NA         |                                |  |                        | Produ                    | Product-Env-Stewards@onsemi.com                 |                       |                            |   |                                    |  |
| Requester Item Number Mfr  | r Item Number  | Mfr Item Name               |            |                                | Effective Date   | Version                | N                        | Manufacturing Site                              |                       | Weight*                    | UOM                                       | Unit Type                          |  |
| HC   | PL2530SD   | 30SD 8PB 1MB 2-CH T&I       |            |                                | 2023-06-08 L   |                        | LITEONFG                 |   | 542.964               | mg                         | Each                                      |                                    |  |
| Manufacturing Proccess Information   |  | •                           |            |                                | •  |                        | ŀ                        |   |                       |                            | ·   |                                    |  |
| Terminal Plating / Grid Array Material   | Terminal Base  | Terminal Base Alloy J-STI   |            | Rating                         | Peak Process Body Tempera  |                        | emperatur                | ure Max Time at Peak Tempera                    |                       | ture Num                   | ber of Reflow Cy                          | cles                               |  |
| Matte Tin (Sn) - annealed CU Alloy   |  | 1                           |            | 225                            |  | С                      | 30                       | seco  | nds 3                 |                            |   |                                    |  |
| Comments   |  |                             |            |                                |  |                        |                          |   |                       |                            |   |                                    |  |
| evel 1 - maximum time at peak temperature durin  | ng soldering is 10-3   | 0 seconds                   |            |                                |  |                        |                          |   |                       |                            |   |                                    |  |
| For more information regarding material composi-   | ition please refer to  | page 3                      |            |                                |  |                        |                          |   |                       |                            |   |                                    |  |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | Supplier Acceptance  | * Accepted  |   |   |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight  | Unit of Measure | Level    | Substance  | CAS        | Exempt | Weight  | Unit of Measure |
|----------------------|---------|-----------------|----------|--|------------|--------|---------|-----------------|
| Coupling Gel         | 64.0    | mg              | Supplier | 3-Methacryloxypropyltrimethoxysilane<br>(C10H20O5Si) | 2530-85-0  |        | 64      | mg              |
| Die                  | 0.099   | mg              | В        | Gallium Arsenide (AsGa)                              | 1303-00-0  |        | 0.033   | mg              |
|                      |         |                 | Supplier | Silicon (Si)   | 7440-21-3  |        | 0.066   | mg              |
| Die Attach           | 0.25    | mg              | Supplier | Silver (Ag)  | 7440-22-4  |        | 0.2075  | mg              |
|                      |         |                 | Supplier | Ortho Cresol Novolac Resin                           | 29690-82-2 |        | 0.0425  | mg              |
| Lead Frame           | 115.0   | mg              | Supplier | Zinc (Zn)  | 7440-66-6  |        | 0.138   | mg              |
|                      |         |                 | Supplier | Iron (Fe)  | 7439-89-6  |        | 2.7125  | mg              |
|                      |         |                 | Supplier | Copper (Cu)  | 7440-50-8  |        | 112.125 | mg              |
|                      |         |                 | Supplier | Phosphorus (P)                                       | 7723-14-0  |        | 0.0245  | mg              |
| Mold Compound-Black  | 93.303  | mg              | Supplier | Brominated Epoxy Resin-2                             | 68541-56-0 |        | 2.3325  | mg              |
|                      |         |                 | Supplier | Ortho Cresol Novolac Resin                           | 29690-82-2 |        | 13.995  | mg              |
|                      |         |                 | В        | Antimony Trioxide (Sb2O3)                            | 1309-64-4  |        | 1.866   | mg              |
|                      |         |                 | Supplier | Carbon Black (C)                                     | 1333-86-4  |        | 0.4695  | mg              |
|                      |         |                 | Supplier | Fused Silica (SiO2)                                  | 60676-86-0 |        | 65.31   | mg              |
|                      |         |                 | Supplier | Phenolic Resin (Novolac)                             | 9003-35-4  |        | 9.33    | mg              |
| Mold Compound-White  | 258.662 | mg              | Supplier | Titanium Dioxide (TiO2)                              | 13463-67-7 |        | 52.4    | mg              |
|                      |         |                 | Supplier | Zirconium Dioxide (ZrO2)                             | 1314-23-4  |        | 1.3     | mg              |
|                      |         |                 | Supplier | Ortho Cresol Novolac Resin                           | 29690-82-2 |        | 196.662 | mg              |
|                      |         |                 | Supplier | Silica Amorphous (SiO2)                              | 7631-86-9  |        | 5.6     | mg              |
|                      |         |                 | Supplier | Aluminum Trioxide (Al2O3)                            | 1344-28-1  |        | 2.7     | mg              |
| Plating              | 11.6    | mg              | Supplier | Tin (Sn)   | 7440-31-5  |        | 11.6    | mg              |
| Wire Bond - Au       | 0.05    | mg              | Supplier | Gold (Au)  | 7440-57-5  |        | 0.05    | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).